

SBR10U45SP5

10A SBR® **SUPER BARRIER RECTIFIER** PowerDI[®]5

Features

- Designed as Bypass Diodes for Solar Panels
- Selectively Rated for 200°C Maximum Junction Temperature for High Thermal Reliability
- Patented Super Barrier Rectifier Technology
- High Forward Surge Capability
- Ultra Low Forward Voltage Drop
- **Excellent High Temperature Stability**
- Lead Free Finish, RoHS Compliant (Note 1)

Mechanical Data

- Case: PowerDI®5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 🚳
- Weight: 0.093 grams (approximate)





LEFT PIN O-**BOTTOMSIDE** HEAT SINK RIGHT PIN O-

Note: Pins Left & Right must be electrically connected at the printed circuit board.

Ordering Information (Note 2)

Part Number	Case	Packaging	
SBR10U45SP5-13	PowerDI [®] 5	5000/Tape & Reel	

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes
- 2. For packaging details, go to our website at http://www.diodes.com.

Marking Information



S10U45S = Product Type Marking Code Office Manufacturers' Code Marking K = Factory Designator YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 08 for 2008) WW = Week code (01 - 53)



Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	45	٧
RMS Reverse Voltage	V _{R(RMS)}	32	V
Average Rectified Output Current	lo	10	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	275	А
Repetitive Peak Avalanche Power (1µs, 25°C)	P _{ARM}	30000	W

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Ambient (Note 3) Thermal Resistance Junction to Ambient (Note 4)		$R_{ hetaJA} \ R_{ hetaJA}$	73 31	°C/W
	V _R ≤ 80% V _{RRM}		-65 to +150	
Operating Temperature Range	V _R ≤ 50% V _{RRM}	T_J	≤180	°C
	DC Forward Mode		≤200	
Storage Temperature Range		T _{STG}	-65 to +175	°C

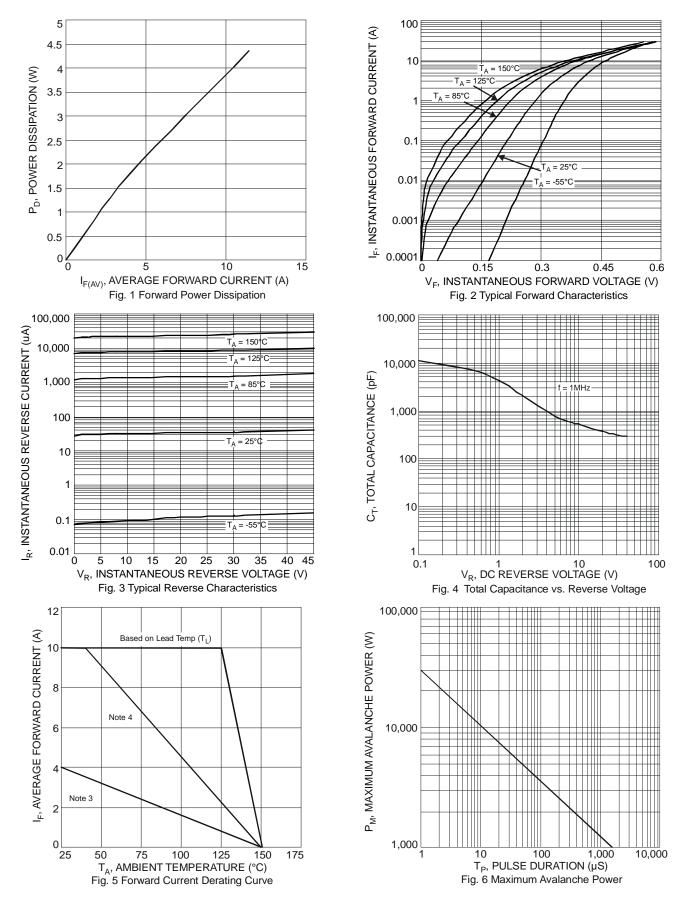
Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	45	-	-	V	$I_R = 0.3 \text{mA}$
		-	-	0.42		$I_F = 8A, T_J = 25^{\circ}C$
Forward Voltage Drop	V _F	-	0.42	0.47	V	$I_F = 10A, T_J = 25^{\circ}C$
		-	0.38	0.41		$I_F = 10A, T_J = 125^{\circ}C$
Leakage Current (Note 5)		-	0.05	0.3		$V_R = 45V, T_J = 25^{\circ}C$
	I_R	-	-	15	mA	$V_R = 45V, T_J = 100^{\circ}C$
		-	28.0	75		$V_R = 45V, T_J = 150^{\circ}C$

Notes:

- 3. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per http://www.diodes.com.
- 4. Polymide PCB, 2oz. Copper. Cathode pad dimensions 18.8mm x 14.4mm. Anode pad dimensions 5.6mm x 14.4mm.
 5. Short duration pulse test used to minimize self-heating effect.

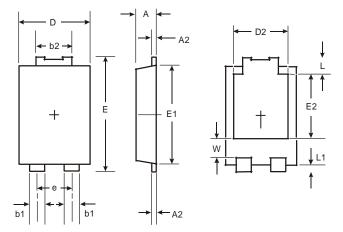




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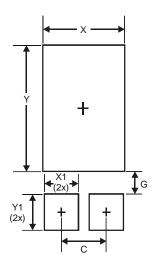


Package Outline Dimensions



PowerDI [®] 5				
Dim	Min	Max		
Α	1.05	1.15		
A2	0.33	0.43		
b1	0.80	0.99		
b2	1.70	1.88		
D	3.90	4.05		
D2	3.054 Typ			
Е	6.40	6.60		
е	1.84 Typ			
E1	5.30	5.45		
E2	3.549 Typ			
L	0.75	0.95		
L1	0.50	0.65		
W	1.10	1.41		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
С	1.840
G	0.852
Х	3.360
X1	1.390
Υ	4.860
Y1	1.400



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